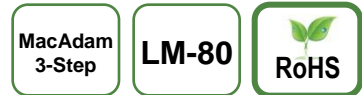


**Acrich MJT 5630**

SAW8KG0B (Cool, Neutral, Warm)



## Product Brief

### Description

- This surface-mount LED comes in standard package dimension.
- It has a substrate made up of a molded plastic reflector sitting on top of a bent lead frame.
- The die is attached within the reflector cavity and the cavity is encapsulated by silicone.
- The package design coupled with careful selection of component materials allow these products to perform with high reliability.

### Features and Benefits

- White colored SMT package.
- Pb-free Reflow Soldering
- Suitable for all SMT
- Lead Free and RoHS compliant

### Key Applications

- Interior lighting
- General lighting
- Indoor and out door displays
- Architectural / Decorative lighting

**Table 1. Product Selection Table**

| Part Number | CCT           |       |       |       |
|-------------|---------------|-------|-------|-------|
|             | Color         | Min.  | Typ.  | Max.  |
| SAW8KG0B    | Cool White    | 4700K | 5600K | 7000K |
| SAW8KG0B    | Neutral White | 3700K | 4200K | 4700K |
| SAW8KG0B    | Warm White    | 2600K | 3000K | 3700K |

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  - Handling of Silicone Resin for LEDs
  - Precaution For Use
  - Company Information
-

## Product Nomenclature

**Table 2. Part Numbering System : X<sub>1</sub>X<sub>2</sub>X<sub>3</sub>X<sub>4</sub>X<sub>5</sub>X<sub>6</sub>X<sub>7</sub>X<sub>8</sub>**

| Part Number Code | Description    | Part Number | Value   |
|------------------|----------------|-------------|---------|
| X <sub>1</sub>   | Company        | S           | SSC     |
| X <sub>2</sub>   | Package series | A           | Acrich  |
| X <sub>3</sub>   | Color          | W           | White   |
| X <sub>4</sub>   | CRI            | 8           | CRI80   |
| X <sub>5</sub>   | Series number  | K           | MJT5630 |
| X <sub>6</sub>   | Voltage        | G           |         |
| X <sub>7</sub>   | PCB type       | 0           | Emitter |
| X <sub>8</sub>   | Revision No.   | B           |         |

**Table 3. Lot Numbering System : Y<sub>1</sub>Y<sub>2</sub>Y<sub>3</sub>Y<sub>4</sub>Y<sub>5</sub>Y<sub>6</sub>Y<sub>7</sub>Y<sub>8</sub>Y<sub>9</sub>Y<sub>10</sub>–Y<sub>11</sub>Y<sub>12</sub>Y<sub>13</sub>Y<sub>14</sub>Y<sub>15</sub>Y<sub>16</sub>Y<sub>17</sub>**

| Lot Number Code   | Description         | Lot Number | Value |
|---|---------------------|------------|-------|
| Y <sub>1</sub> Y <sub>2</sub>   | Year                |            |       |
| Y <sub>3</sub>  | Month               |            |       |
| Y <sub>4</sub> Y <sub>5</sub>   | Day                 |            |       |
| Y <sub>6</sub>  | Top View LED series |            |       |
| Y <sub>7</sub> Y <sub>8</sub> Y <sub>9</sub> Y <sub>10</sub>  | Mass order          |            |       |
| Y <sub>11</sub> Y <sub>12</sub> Y <sub>13</sub> Y <sub>14</sub> Y <sub>15</sub> Y <sub>16</sub> Y <sub>17</sub> | Internal Number     |            |       |

## Performance Characteristics

**Table 4. Product Selection Guide,  $I_F=20\text{mA}$ ,  $T_j = 25^\circ\text{C}$ , RH30%**

| Part Number | CCT (K) <sup>[1]</sup> | RANK | Luminous Intensity <sup>[2]</sup> |      | Luminous Flux <sup>[3]</sup> |      | CRI   |
|-------------|------------------------|------|-----------------------------------|------|------------------------------|------|-------|
|             | Typ.                   |      | $I_V$ (cd)                        |      | $\Phi_V$ (lm)                |      | $R_a$ |
|             |                        |      | Min                               | Max  | Min                          | Max  | Min.  |
| SAW8KG0B    | 7000~4700              | W5   | 13.5                              | 14.8 | 41.9                         | 45.9 | 80    |
|             |                        | X8   | 14.8                              | 16.1 | 45.9                         | 49.9 | 80    |
|             |                        | Y1   | 16.1                              | 17.4 | 49.9                         | 53.9 | 80    |
|             |                        | Z4   | 17.4                              | 19.0 | 53.9                         | 58.9 | 80    |
|             |                        | J0   | 19.0                              | 20.3 | 58.9                         | 62.9 | 80    |
|             | 4700~3700              | W5   | 13.5                              | 14.8 | 41.9                         | 45.9 | 80    |
|             |                        | X8   | 14.8                              | 16.1 | 45.9                         | 49.9 | 80    |
|             |                        | Y1   | 16.1                              | 17.4 | 49.9                         | 53.9 | 80    |
|             |                        | Z4   | 17.4                              | 19.0 | 53.9                         | 58.9 | 80    |
|             |                        | J0   | 19.0                              | 20.3 | 58.9                         | 62.9 | 80    |
|             | 3700~2600              | V2   | 12.2                              | 13.5 | 37.8                         | 41.9 | 80    |
|             |                        | W5   | 13.5                              | 14.8 | 41.9                         | 45.9 | 80    |
|             |                        | X8   | 14.8                              | 16.1 | 45.9                         | 49.9 | 80    |
|             |                        | Y1   | 16.1                              | 17.4 | 49.9                         | 53.9 | 80    |
|             |                        | Z4   | 17.4                              | 19.0 | 53.9                         | 58.9 | 80    |

**Notes :**

- (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- (2) Seoul Semiconductor maintains a tolerance of 7% on Intensity and power measurements. The luminous intensity  $I_V$  was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.
- (3) The lumen table is only for reference.

## Performance Characteristics

**Table 5. Characteristics,  $I_F=20\text{mA}$ ,  $T_j=25^\circ\text{C}$ , RH30%**

| Parameter  | Symbol                  | Value |                 |      | Unit       |
|--|-------------------------|-------|-----------------|------|------------|
|  |                         | Min.  | Typ.            | Max. |            |
| Forward Current                                    | $I_F$                   | -     | 20              | 25   | mA         |
| Forward Voltage*                                   | $V_F$                   | 20.7  | 22              | 23   | V          |
| Reverse Voltage                                    | $V_R (I_R=10\text{mA})$ | 0.7   | -               | -    | V          |
| Luminous Intensity* <sup>[1]</sup><br>(3700~7000K) | $I_v$                   | -     | 17.02<br>(52.8) | -    | cd<br>(lm) |
| Luminous Intensity* <sup>[1]</sup><br>(2600~3700K) | $I_v$                   | -     | 16.2<br>(50.1)  | -    |            |
| Viewing Angle <sup>[2]</sup>                       | $2\theta_{1/2}$         | -     | 115             | -    | deg.       |
| Color Rendering Index*                             | $R_a$                   | 80    | 82              | 90   | -          |
| Thermal resistance <sup>[3]</sup>                  | $R\theta_{j-s}$         | -     | 27              | -    | K/W        |
| Power Dissipation ** <sup>[4]</sup>                | $P_d$                   | -     | -               | 0.58 | W          |
| Junction Temperature                               | $T_j$                   | -     | -               | 125  | °C         |
| Operating Temperature                              | $T_{opr}$               | -30   | -               | +85  | °C         |
| Storage Temperature                                | $T_{stg}$               | -40   | -               | +100 | °C         |
| ESD Sensitivity(HBM)                               | -                       | 5     | -               | -    | KV         |

### Notes :

- (1) The luminous intensity  $I_v$  was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.
- (2)  $2\theta_{1/2}$  is the off-axis where the luminous intensity is 1/2 of the peak intensity.
- (3) Thermal resistance:  $R_{thJS}$  (Junction / solder)

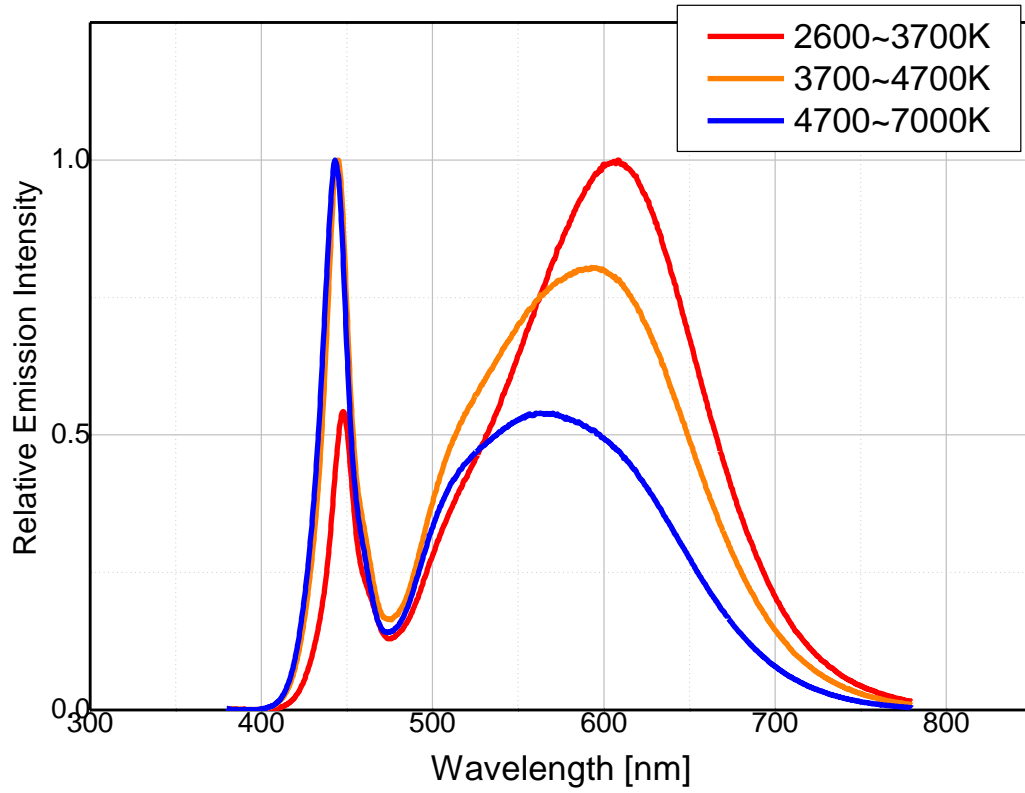
\* Tolerance :  $V_F : \pm 0.4\text{V}$ ,  $I_v : \pm 7\%$ ,  $R_a : \pm 2$ ,  $x, y : \pm 0.007$

- (4) Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.

\*\* LED's properties might be different from suggested values like above and below tables if operation condition will be exceeded our parameter range.

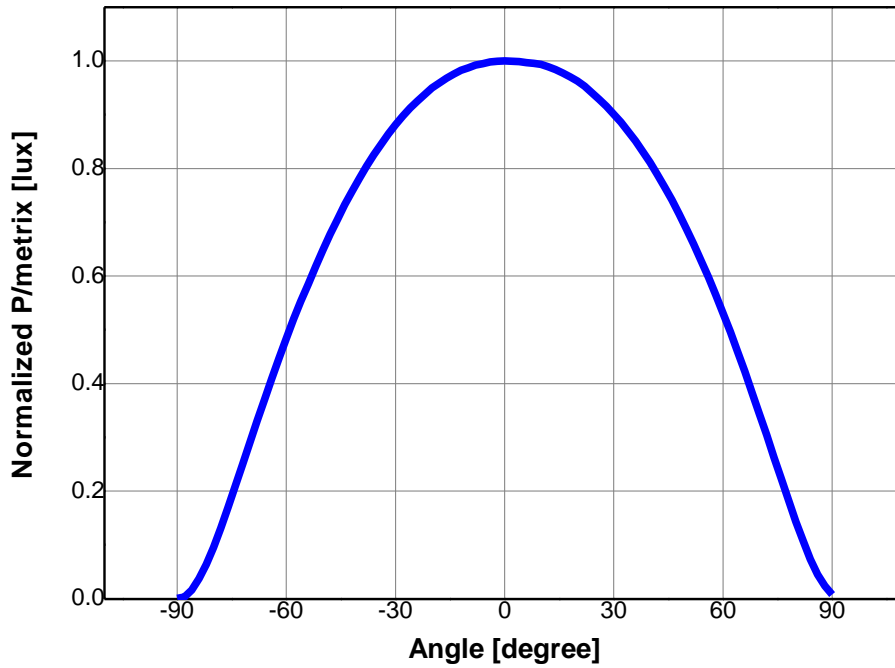
## Relative Spectral Distribution

Fig 1. Color Spectrum,  $I_F=20\text{mA}$ ,  $T_j=25^\circ\text{C}$ , RH30%

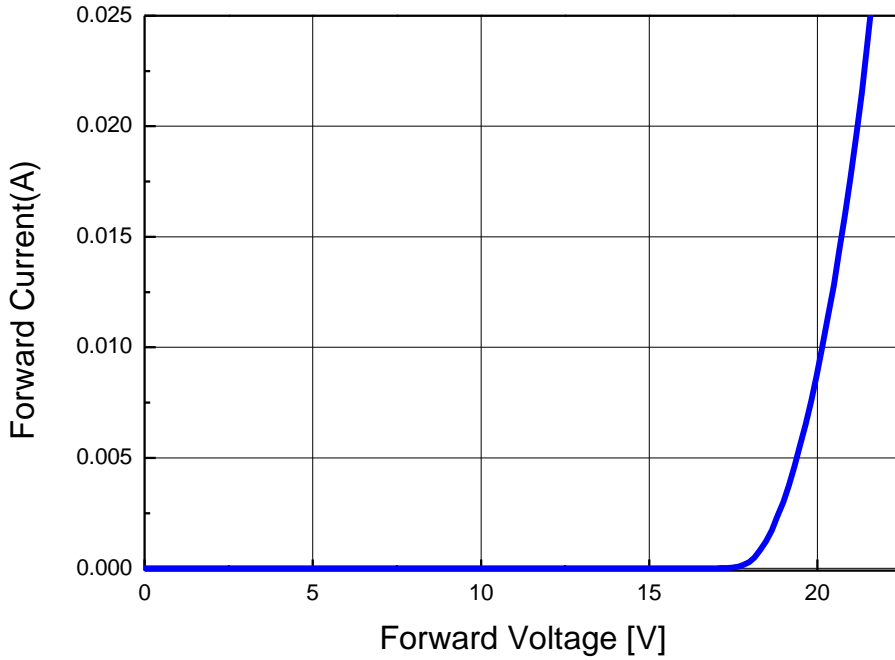
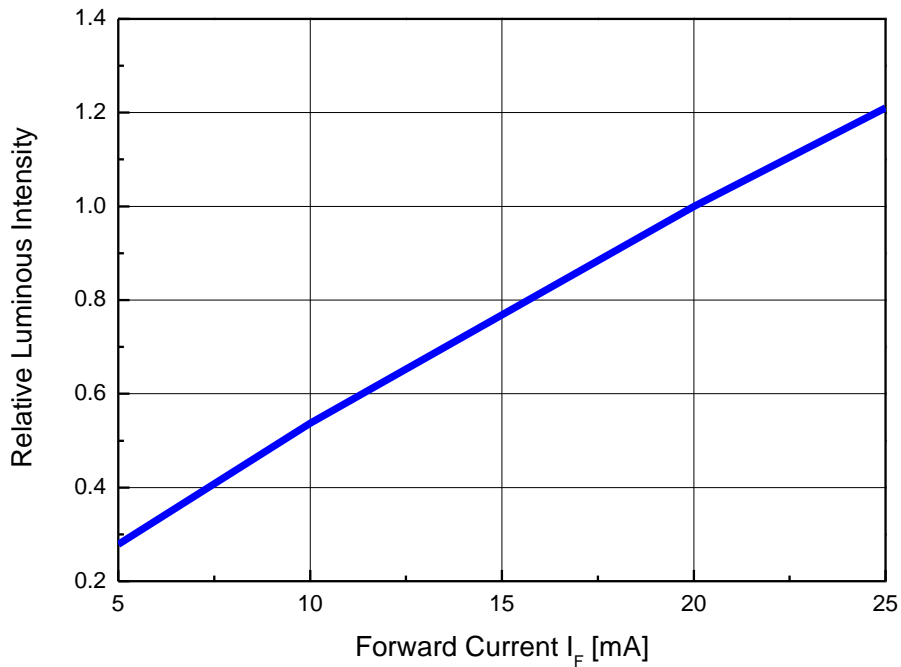


## Luminous Flux Characteristics

Fig 2. Radiant pattern,  $I_F = 20\text{mA}$



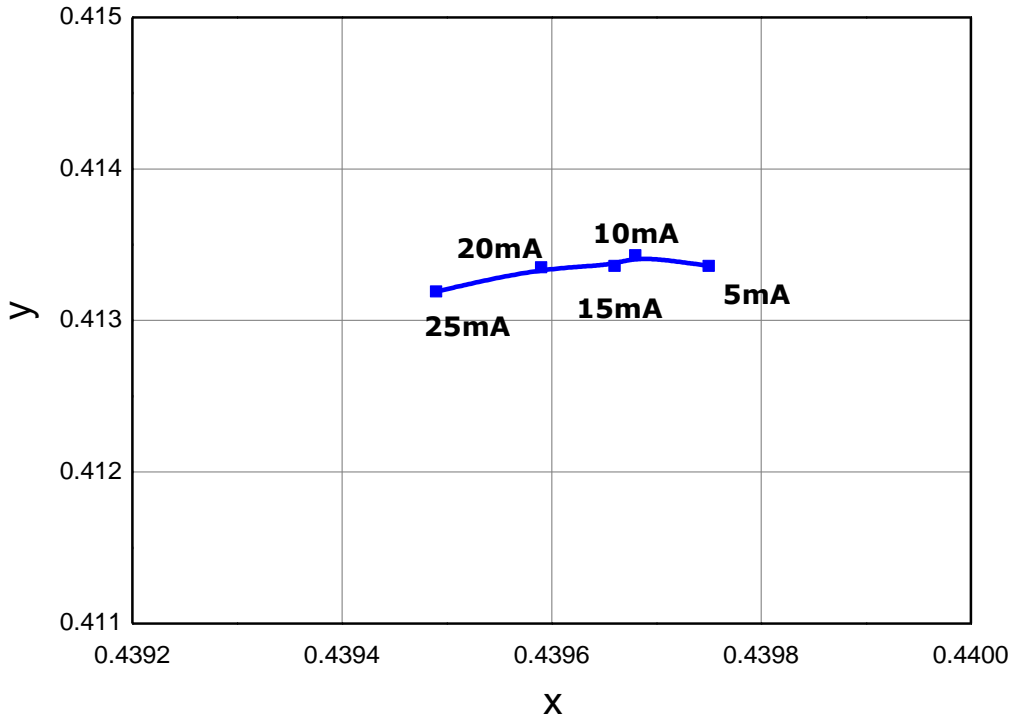
## Forward Current Characteristics

**Fig 3. Forward Voltage vs. Forward Current ,  $T_j=25^\circ\text{C}$** 

**Fig 4. Forward Current vs. Relative Luminous Intensity,  $T_j=25^\circ\text{C}$** 




## Forward Current Characteristics

Fig 5. Forward Current vs. CIE X, Y Shift ,  $T_j=25^\circ\text{C}$



## Junction Temperature Characteristics

Fig 6. Relative Forward Voltage vs. Junction Temperature,  $I_F=20mA$

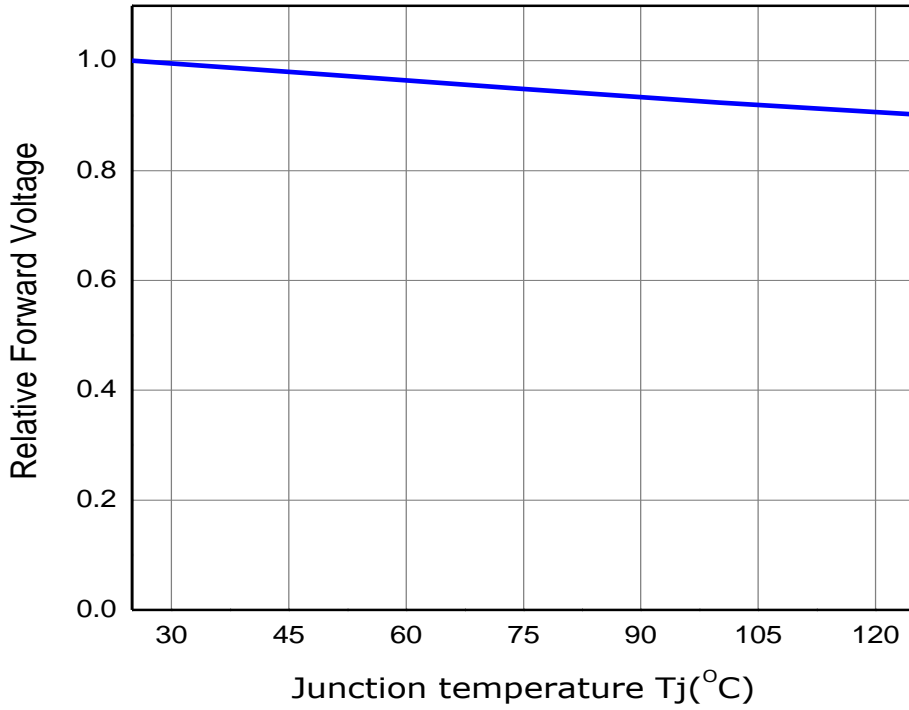
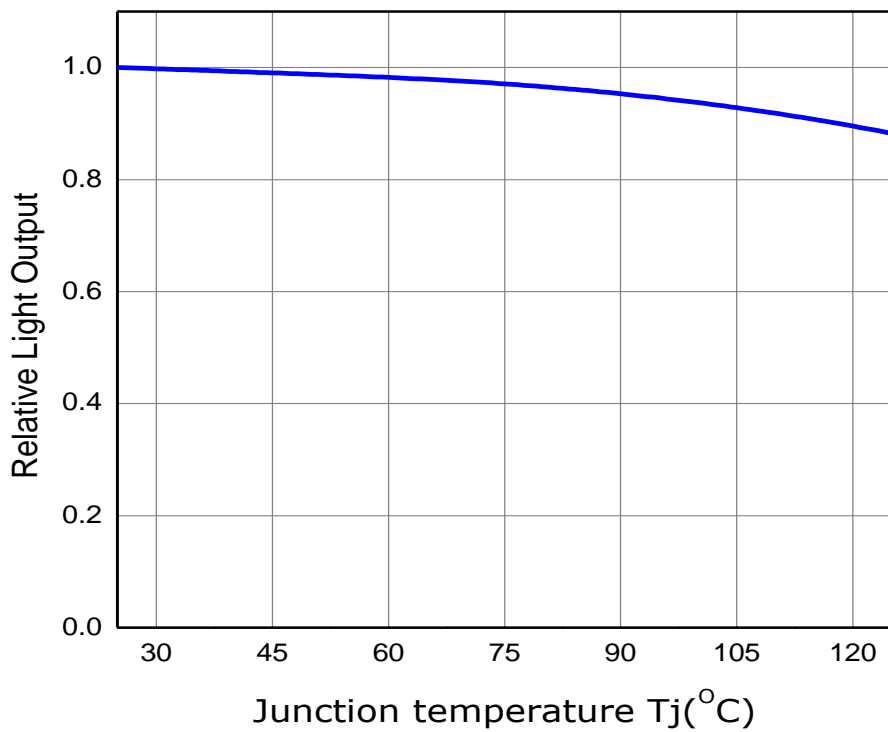
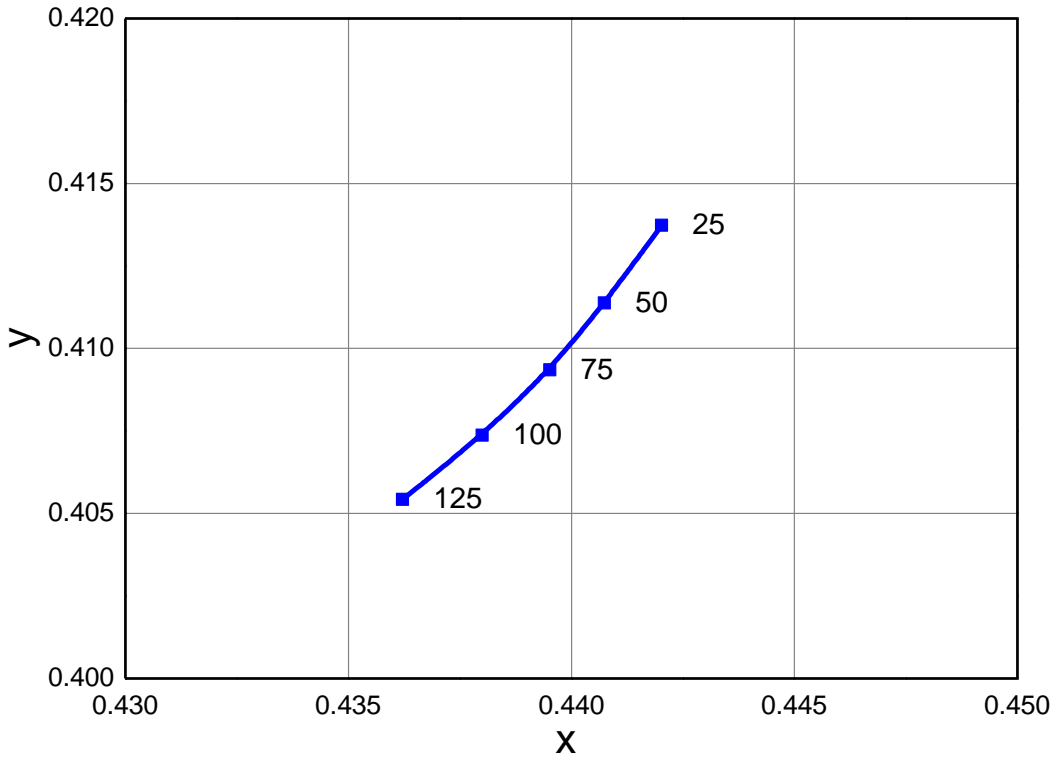


Fig 7. Junction Temp. vs. Relative Light Output,  $I_F=20mA$



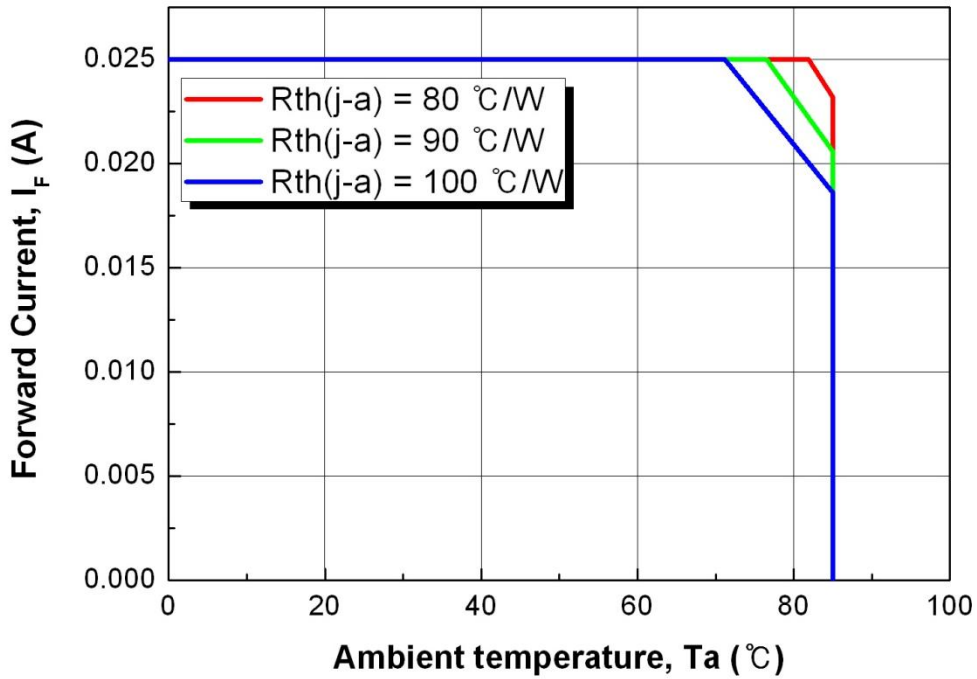
## Junction Temperature Characteristics

Fig 8. Junction Temp. vs. Chromaticity Coordinate ,  $I_F=20mA$



## Ambient Temperature Characteristics

Fig 9. Maximum Forward Current vs. Ambient Temperature,  $T_j(\text{max.}) = 125^\circ\text{C}$ ,  $I_F = 25\text{mA}$



## Color Bin Structure

**Table 6. Bin Code description**

| Part Number | Luminous Flux (lm)<br>@ $I_F = 20\text{mA}$ |      |      | Color<br>Chromaticity<br>Coordinate<br>@ $I_F = 20\text{mA}$ | Typical Forward<br>Voltage ( $V_f$ ) |      |      |
|-------------|---|------|------|--|--------------------------------------|------|------|
|             | Bin Code                                    | Min. | Max. |  | Bin Code                             | Min. | Max. |
| SAW8KG0B    | V2  | 12.2 | 13.5 | Refer to page.15   | A                                    | 20.7 | 21.5 |
|             | W5  | 13.5 | 14.8 |  | B                                    | 21.5 | 22.2 |
|             | X8  | 14.8 | 16.1 |  | C                                    | 22.2 | 23.0 |
|             | Y1  | 16.1 | 17.4 |  |                                      |      |      |
|             | Z4  | 17.4 | 19.0 |  |                                      |      |      |
|             | J0  | 19.0 | 20.3 |  |                                      |      |      |

**Table 7. Intensity rank distribution**

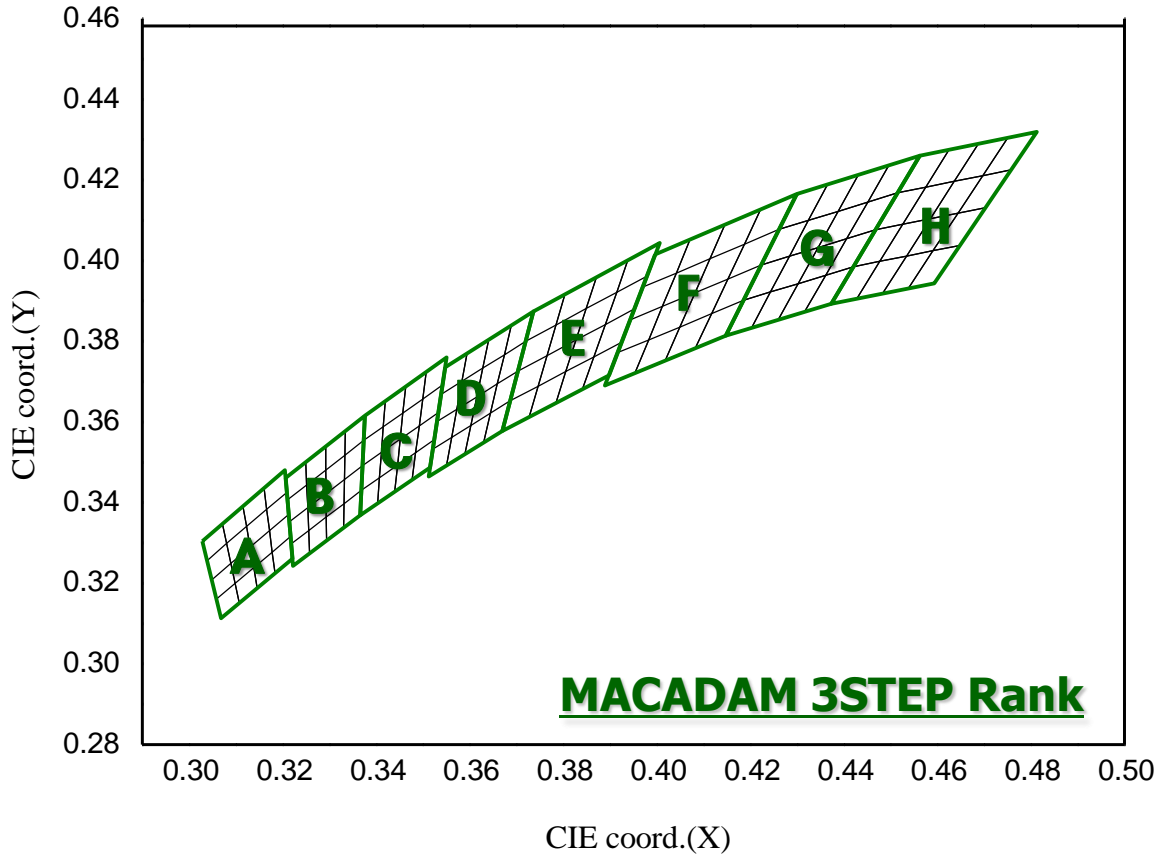
| CCT          | CIE | IV Rank |    |    |    |    |
|--------------|-----|---------|----|----|----|----|
| 6000 ~ 7000K | A   | W5      | X8 | Y1 | Z4 | J0 |
| 5300 ~ 6000K | B   | W5      | X8 | Y1 | Z4 | J0 |
| 4700 ~ 5300K | C   | W5      | X8 | Y1 | Z4 | J0 |
| 4200 ~ 4700K | D   | W5      | X8 | Y1 | Z4 | J0 |
| 3700 ~ 4200K | E   | W5      | X8 | Y1 | Z4 | J0 |
| 3200 ~ 3700K | F   | V2      | W5 | X8 | Y1 | Z4 |
| 2900 ~ 3200K | G   | V2      | W5 | X8 | Y1 | Z4 |
| 2600 ~ 2900K | H   | V2      | W5 | X8 | Y1 | Z4 |

**Notes :**

- (1) All measurements were made under the standardized environment of Seoul Semiconductor  
In order to ensure availability, single color rank will not be orderable.

## Color Bin Structure

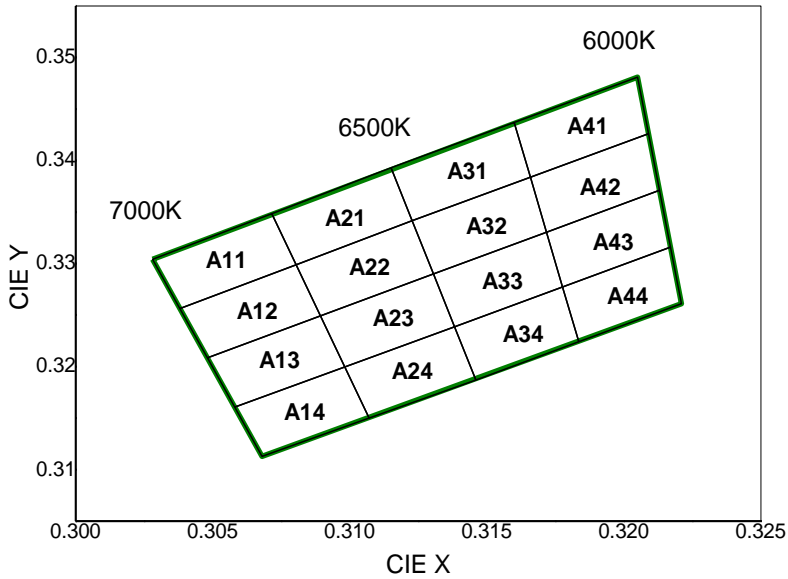
CIE Chromaticity Diagram,  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$



**Notes :**

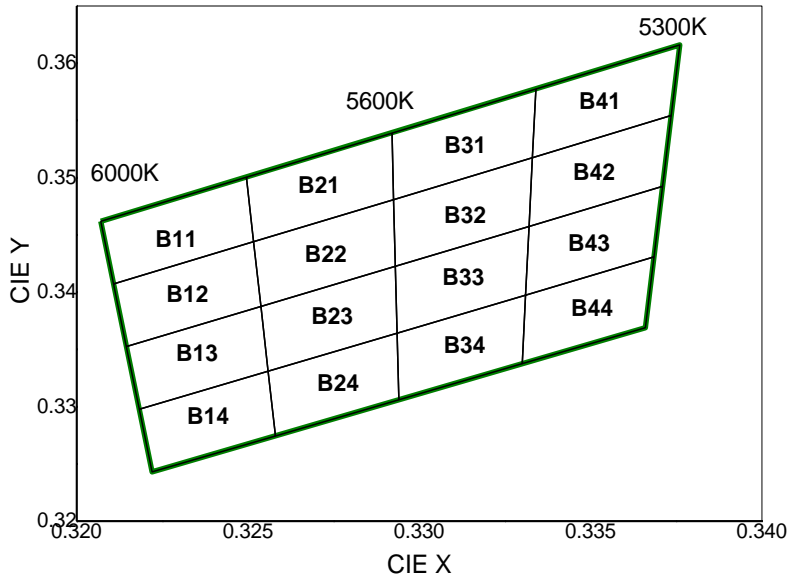
- (1) Energy Star binning applied to all 2600~7000K.
- (2) Measurement Uncertainty of the Color Coordinates :  $\pm 0.007$

## Color Bin Structure

**CIE Chromaticity Diagram (Cool White),  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$** 


| A11    |        | A21    |        | A31    |        | A41    |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3028 | 0.3304 | 0.3072 | 0.3349 | 0.3115 | 0.3393 | 0.3160 | 0.3437 |
| 0.3038 | 0.3256 | 0.3080 | 0.3299 | 0.3123 | 0.3342 | 0.3166 | 0.3384 |
| 0.3080 | 0.3299 | 0.3123 | 0.3342 | 0.3166 | 0.3384 | 0.3209 | 0.3426 |
| 0.3072 | 0.3349 | 0.3115 | 0.3393 | 0.3160 | 0.3437 | 0.3205 | 0.3481 |
| A12    |        | A22    |        | A32    |        | A42    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3038 | 0.3256 | 0.3080 | 0.3299 | 0.3123 | 0.3342 | 0.3166 | 0.3384 |
| 0.3048 | 0.3209 | 0.3089 | 0.3249 | 0.3131 | 0.3290 | 0.3172 | 0.3331 |
| 0.3089 | 0.3249 | 0.3131 | 0.3290 | 0.3172 | 0.3331 | 0.3213 | 0.3371 |
| 0.3080 | 0.3299 | 0.3123 | 0.3342 | 0.3166 | 0.3384 | 0.3209 | 0.3426 |
| A13    |        | A23    |        | A33    |        | A43    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3048 | 0.3209 | 0.3089 | 0.3249 | 0.3131 | 0.3290 | 0.3172 | 0.3331 |
| 0.3058 | 0.3161 | 0.3098 | 0.3200 | 0.3138 | 0.3239 | 0.3178 | 0.3277 |
| 0.3098 | 0.3200 | 0.3138 | 0.3239 | 0.3178 | 0.3277 | 0.3217 | 0.3316 |
| 0.3089 | 0.3249 | 0.3131 | 0.3290 | 0.3172 | 0.3331 | 0.3213 | 0.3371 |
| A14    |        | A24    |        | A34    |        | A44    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3058 | 0.3161 | 0.3098 | 0.3200 | 0.3138 | 0.3239 | 0.3178 | 0.3277 |
| 0.3068 | 0.3113 | 0.3107 | 0.3150 | 0.3146 | 0.3187 | 0.3184 | 0.3224 |
| 0.3107 | 0.3150 | 0.3146 | 0.3187 | 0.3184 | 0.3224 | 0.3221 | 0.3261 |
| 0.3098 | 0.3200 | 0.3138 | 0.3239 | 0.3178 | 0.3277 | 0.3217 | 0.3316 |

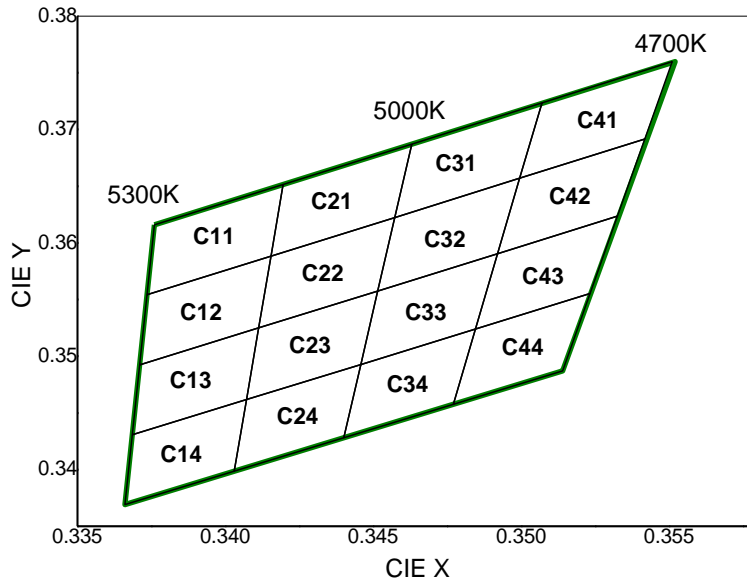
## Color Bin Structure

**CIE Chromaticity Diagram (Cool White),  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$** 


| B11    |        | B21    |        | B31    |        | B41    |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3207 | 0.3462 | 0.3250 | 0.3501 | 0.3292 | 0.3539 | 0.3334 | 0.3578 |
| 0.3211 | 0.3407 | 0.3252 | 0.3444 | 0.3293 | 0.3481 | 0.3333 | 0.3518 |
| 0.3252 | 0.3444 | 0.3293 | 0.3481 | 0.3333 | 0.3518 | 0.3374 | 0.3554 |
| 0.3250 | 0.3501 | 0.3292 | 0.3539 | 0.3334 | 0.3578 | 0.3376 | 0.3616 |
| B12    |        | B22    |        | B32    |        | B42    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3211 | 0.3407 | 0.3252 | 0.3444 | 0.3293 | 0.3481 | 0.3333 | 0.3518 |
| 0.3215 | 0.3353 | 0.3254 | 0.3388 | 0.3293 | 0.3423 | 0.3332 | 0.3458 |
| 0.3254 | 0.3388 | 0.3293 | 0.3423 | 0.3332 | 0.3458 | 0.3371 | 0.3493 |
| 0.3252 | 0.3444 | 0.3293 | 0.3481 | 0.3333 | 0.3518 | 0.3374 | 0.3554 |
| B13    |        | B23    |        | B33    |        | B43    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3215 | 0.3353 | 0.3254 | 0.3388 | 0.3293 | 0.3423 | 0.3332 | 0.3458 |
| 0.3218 | 0.3298 | 0.3256 | 0.3331 | 0.3294 | 0.3364 | 0.3331 | 0.3398 |
| 0.3256 | 0.3331 | 0.3294 | 0.3364 | 0.3331 | 0.3398 | 0.3369 | 0.3431 |
| 0.3254 | 0.3388 | 0.3293 | 0.3423 | 0.3332 | 0.3458 | 0.3371 | 0.3493 |
| B14    |        | B24    |        | B34    |        | B44    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3218 | 0.3298 | 0.3256 | 0.3331 | 0.3294 | 0.3364 | 0.3331 | 0.3398 |
| 0.3222 | 0.3243 | 0.3258 | 0.3275 | 0.3294 | 0.3306 | 0.3330 | 0.3338 |
| 0.3258 | 0.3275 | 0.3294 | 0.3306 | 0.3330 | 0.3338 | 0.3366 | 0.3369 |
| 0.3256 | 0.3331 | 0.3294 | 0.3364 | 0.3331 | 0.3398 | 0.3369 | 0.3431 |

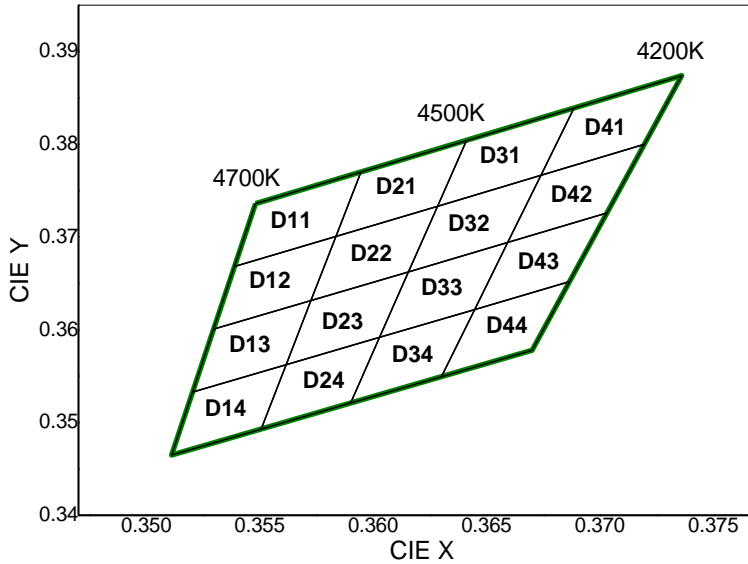


## Color Bin Structure

**CIE Chromaticity Diagram (Cool White),  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$** 


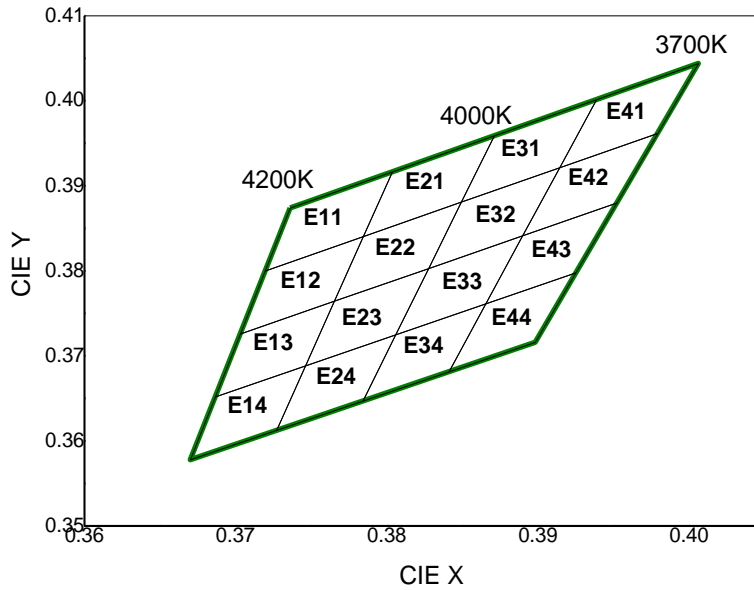
| C11    |        | C21    |        | C31    |        | C41    |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3376 | 0.3616 | 0.3420 | 0.3652 | 0.3463 | 0.3687 | 0.3507 | 0.3724 |
| 0.3374 | 0.3554 | 0.3415 | 0.3588 | 0.3457 | 0.3622 | 0.3500 | 0.3657 |
| 0.3415 | 0.3588 | 0.3457 | 0.3622 | 0.3500 | 0.3657 | 0.3542 | 0.3692 |
| 0.3420 | 0.3652 | 0.3463 | 0.3687 | 0.3507 | 0.3724 | 0.3551 | 0.3760 |
| C12    |        | C22    |        | C32    |        | C42    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3374 | 0.3554 | 0.3415 | 0.3588 | 0.3457 | 0.3622 | 0.3500 | 0.3657 |
| 0.3371 | 0.3493 | 0.3411 | 0.3525 | 0.3452 | 0.3558 | 0.3492 | 0.3591 |
| 0.3411 | 0.3525 | 0.3452 | 0.3558 | 0.3492 | 0.3591 | 0.3533 | 0.3624 |
| 0.3415 | 0.3588 | 0.3457 | 0.3622 | 0.3500 | 0.3657 | 0.3542 | 0.3692 |
| C13    |        | C23    |        | C33    |        | C43    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3371 | 0.3493 | 0.3411 | 0.3525 | 0.3452 | 0.3558 | 0.3492 | 0.3591 |
| 0.3369 | 0.3431 | 0.3407 | 0.3462 | 0.3446 | 0.3493 | 0.3485 | 0.3524 |
| 0.3407 | 0.3462 | 0.3446 | 0.3493 | 0.3485 | 0.3524 | 0.3523 | 0.3555 |
| 0.3411 | 0.3525 | 0.3452 | 0.3558 | 0.3492 | 0.3591 | 0.3533 | 0.3624 |
| C14    |        | C24    |        | C34    |        | C44    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3369 | 0.3431 | 0.3407 | 0.3462 | 0.3446 | 0.3493 | 0.3485 | 0.3524 |
| 0.3366 | 0.3369 | 0.3403 | 0.3399 | 0.3440 | 0.3428 | 0.3477 | 0.3458 |
| 0.3403 | 0.3399 | 0.3440 | 0.3428 | 0.3477 | 0.3458 | 0.3514 | 0.3487 |
| 0.3407 | 0.3462 | 0.3446 | 0.3493 | 0.3485 | 0.3524 | 0.3523 | 0.3555 |

## Color Bin Structure

**CIE Chromaticity Diagram (Neutral White),  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$** 


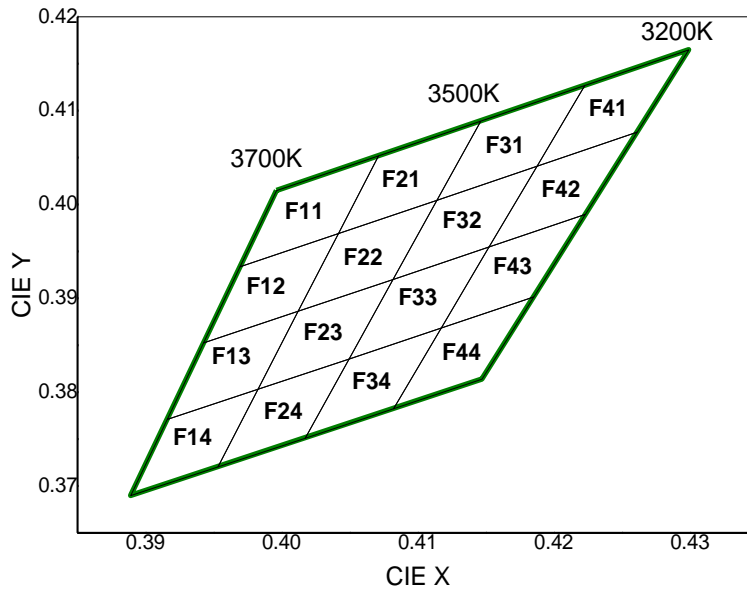
| D11    |        | D21    |        | D31    |        | D41    |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3548 | 0.3736 | 0.3595 | 0.3770 | 0.3641 | 0.3804 | 0.3689 | 0.3839 |
| 0.3539 | 0.3668 | 0.3584 | 0.3701 | 0.3628 | 0.3733 | 0.3674 | 0.3767 |
| 0.3584 | 0.3701 | 0.3628 | 0.3733 | 0.3674 | 0.3767 | 0.3720 | 0.3800 |
| 0.3595 | 0.3770 | 0.3641 | 0.3804 | 0.3689 | 0.3839 | 0.3736 | 0.3874 |
| D12    |        | D22    |        | D32    |        | D42    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3539 | 0.3668 | 0.3584 | 0.3701 | 0.3628 | 0.3733 | 0.3674 | 0.3767 |
| 0.3530 | 0.3601 | 0.3573 | 0.3632 | 0.3616 | 0.3663 | 0.3659 | 0.3694 |
| 0.3573 | 0.3632 | 0.3616 | 0.3663 | 0.3659 | 0.3694 | 0.3703 | 0.3726 |
| 0.3584 | 0.3701 | 0.3628 | 0.3733 | 0.3674 | 0.3767 | 0.3720 | 0.3800 |
| D13    |        | D23    |        | D33    |        | D43    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3530 | 0.3601 | 0.3573 | 0.3632 | 0.3616 | 0.3663 | 0.3659 | 0.3694 |
| 0.3520 | 0.3533 | 0.3562 | 0.3562 | 0.3603 | 0.3592 | 0.3645 | 0.3622 |
| 0.3562 | 0.3562 | 0.3603 | 0.3592 | 0.3645 | 0.3622 | 0.3687 | 0.3652 |
| 0.3573 | 0.3632 | 0.3616 | 0.3663 | 0.3659 | 0.3694 | 0.3703 | 0.3726 |
| D14    |        | D24    |        | D34    |        | D44    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3520 | 0.3533 | 0.3562 | 0.3562 | 0.3603 | 0.3592 | 0.3645 | 0.3622 |
| 0.3511 | 0.3465 | 0.3551 | 0.3493 | 0.3590 | 0.3521 | 0.3630 | 0.3550 |
| 0.3551 | 0.3493 | 0.3590 | 0.3521 | 0.3630 | 0.3550 | 0.3670 | 0.3578 |
| 0.3562 | 0.3562 | 0.3603 | 0.3592 | 0.3645 | 0.3622 | 0.3687 | 0.3652 |

## Color Bin Structure

**CIE Chromaticity Diagram (Neutral White),  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$** 


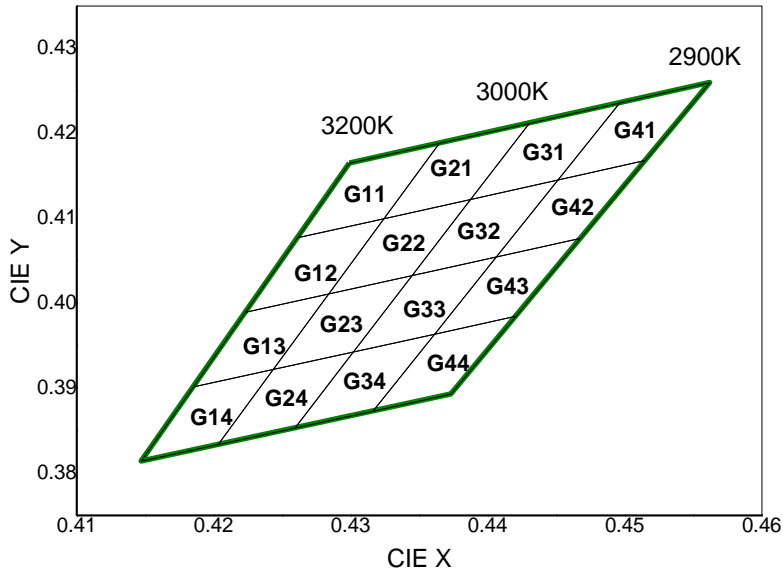
| E11    |        | E21    |        | E31    |        | E41    |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3736 | 0.3874 | 0.3804 | 0.3917 | 0.3871 | 0.3959 | 0.3939 | 0.4002 |
| 0.3720 | 0.3800 | 0.3784 | 0.3841 | 0.3849 | 0.3881 | 0.3914 | 0.3922 |
| 0.3784 | 0.3841 | 0.3849 | 0.3881 | 0.3914 | 0.3922 | 0.3979 | 0.3962 |
| 0.3804 | 0.3917 | 0.3871 | 0.3959 | 0.3939 | 0.4002 | 0.4006 | 0.4044 |
| E12    |        | E22    |        | E32    |        | E42    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3720 | 0.3800 | 0.3784 | 0.3841 | 0.3849 | 0.3881 | 0.3914 | 0.3922 |
| 0.3703 | 0.3726 | 0.3765 | 0.3765 | 0.3828 | 0.3803 | 0.3890 | 0.3842 |
| 0.3765 | 0.3765 | 0.3828 | 0.3803 | 0.3890 | 0.3842 | 0.3952 | 0.3880 |
| 0.3784 | 0.3841 | 0.3849 | 0.3881 | 0.3914 | 0.3922 | 0.3979 | 0.3962 |
| E13    |        | E23    |        | E33    |        | E43    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3703 | 0.3726 | 0.3765 | 0.3765 | 0.3828 | 0.3803 | 0.3890 | 0.3842 |
| 0.3687 | 0.3652 | 0.3746 | 0.3689 | 0.3806 | 0.3725 | 0.3865 | 0.3762 |
| 0.3746 | 0.3689 | 0.3806 | 0.3725 | 0.3865 | 0.3762 | 0.3925 | 0.3798 |
| 0.3765 | 0.3765 | 0.3828 | 0.3803 | 0.3890 | 0.3842 | 0.3952 | 0.3880 |
| E14    |        | E24    |        | E34    |        | E44    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3687 | 0.3652 | 0.3746 | 0.3689 | 0.3806 | 0.3725 | 0.3865 | 0.3762 |
| 0.3670 | 0.3578 | 0.3727 | 0.3613 | 0.3784 | 0.3647 | 0.3841 | 0.3682 |
| 0.3727 | 0.3613 | 0.3784 | 0.3647 | 0.3841 | 0.3682 | 0.3898 | 0.3716 |
| 0.3746 | 0.3689 | 0.3806 | 0.3725 | 0.3865 | 0.3762 | 0.3925 | 0.3798 |

## Color Bin Structure

**CIE Chromaticity Diagram (Warm White),  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$** 


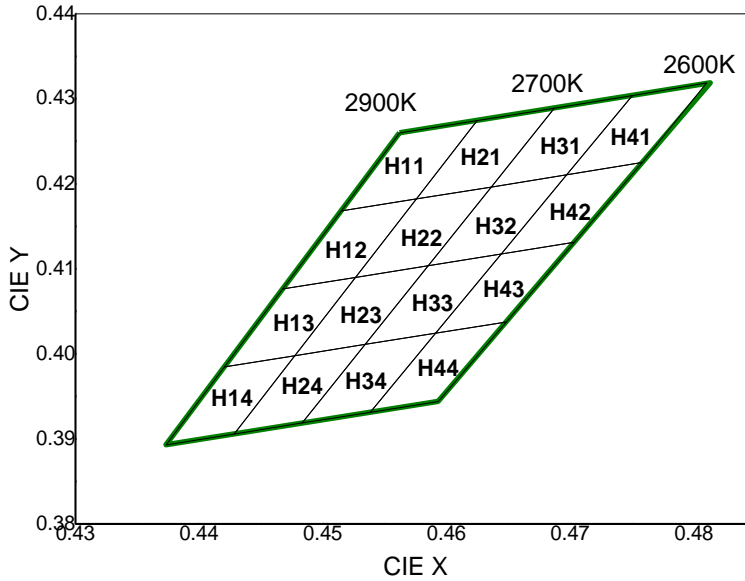
| F11    |        | F21    |        | F31    |        | F41    |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3996 | 0.4015 | 0.4071 | 0.4052 | 0.4146 | 0.4089 | 0.4223 | 0.4127 |
| 0.3969 | 0.3934 | 0.4042 | 0.3969 | 0.4114 | 0.4005 | 0.4187 | 0.4041 |
| 0.4042 | 0.3969 | 0.4114 | 0.4005 | 0.4187 | 0.4041 | 0.4261 | 0.4077 |
| 0.4071 | 0.4052 | 0.4146 | 0.4089 | 0.4223 | 0.4127 | 0.4299 | 0.4165 |
| F12    |        | F22    |        | F32    |        | F42    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3969 | 0.3934 | 0.4042 | 0.3969 | 0.4114 | 0.4005 | 0.4187 | 0.4041 |
| 0.3943 | 0.3853 | 0.4012 | 0.3886 | 0.4082 | 0.3920 | 0.4152 | 0.3955 |
| 0.4012 | 0.3886 | 0.4082 | 0.3920 | 0.4152 | 0.3955 | 0.4223 | 0.3990 |
| 0.4042 | 0.3969 | 0.4114 | 0.4005 | 0.4187 | 0.4041 | 0.4261 | 0.4077 |
| F13    |        | F23    |        | F33    |        | F43    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3943 | 0.3853 | 0.4012 | 0.3886 | 0.4082 | 0.3920 | 0.4152 | 0.3955 |
| 0.3916 | 0.3771 | 0.3983 | 0.3803 | 0.4049 | 0.3836 | 0.4117 | 0.3869 |
| 0.3983 | 0.3803 | 0.4049 | 0.3836 | 0.4117 | 0.3869 | 0.4185 | 0.3902 |
| 0.4012 | 0.3886 | 0.4082 | 0.3920 | 0.4152 | 0.3955 | 0.4223 | 0.3990 |
| F14    |        | F24    |        | F34    |        | F44    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.3916 | 0.3771 | 0.3983 | 0.3803 | 0.4049 | 0.3836 | 0.4117 | 0.3869 |
| 0.3889 | 0.3690 | 0.3953 | 0.3721 | 0.4017 | 0.3751 | 0.4082 | 0.3783 |
| 0.3953 | 0.3721 | 0.4017 | 0.3751 | 0.4082 | 0.3783 | 0.4147 | 0.3814 |
| 0.3983 | 0.3803 | 0.4049 | 0.3836 | 0.4117 | 0.3869 | 0.4185 | 0.3902 |

## Color Bin Structure

**CIE Chromaticity Diagram (Warm White),  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$** 


| G11    |        | G21    |        | G31    |        | G41    |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.4299 | 0.4165 | 0.4364 | 0.4188 | 0.4430 | 0.4212 | 0.4496 | 0.4236 |
| 0.4261 | 0.4077 | 0.4324 | 0.4099 | 0.4387 | 0.4122 | 0.4451 | 0.4145 |
| 0.4324 | 0.4100 | 0.4387 | 0.4122 | 0.4451 | 0.4145 | 0.4514 | 0.4168 |
| 0.4365 | 0.4189 | 0.4430 | 0.4212 | 0.4496 | 0.4236 | 0.4562 | 0.4260 |
| G12    |        | G22    |        | G32    |        | G42    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.4261 | 0.4077 | 0.4324 | 0.4100 | 0.4387 | 0.4122 | 0.4451 | 0.4145 |
| 0.4223 | 0.3990 | 0.4284 | 0.4011 | 0.4345 | 0.4033 | 0.4406 | 0.4055 |
| 0.4284 | 0.4011 | 0.4345 | 0.4033 | 0.4406 | 0.4055 | 0.4468 | 0.4077 |
| 0.4324 | 0.4100 | 0.4387 | 0.4122 | 0.4451 | 0.4145 | 0.4515 | 0.4168 |
| G13    |        | G23    |        | G33    |        | G43    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.4223 | 0.3990 | 0.4284 | 0.4011 | 0.4345 | 0.4033 | 0.4406 | 0.4055 |
| 0.4185 | 0.3902 | 0.4243 | 0.3922 | 0.4302 | 0.3943 | 0.4361 | 0.3964 |
| 0.4243 | 0.3922 | 0.4302 | 0.3943 | 0.4361 | 0.3964 | 0.4420 | 0.3985 |
| 0.4284 | 0.4011 | 0.4345 | 0.4033 | 0.4406 | 0.4055 | 0.4468 | 0.4077 |
| G14    |        | G24    |        | G34    |        | G44    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.4243 | 0.3922 | 0.4302 | 0.3943 | 0.4302 | 0.3943 | 0.4361 | 0.3964 |
| 0.4203 | 0.3834 | 0.4259 | 0.3853 | 0.4259 | 0.3853 | 0.4316 | 0.3873 |
| 0.4147 | 0.3814 | 0.4203 | 0.3834 | 0.4316 | 0.3873 | 0.4373 | 0.3893 |
| 0.4185 | 0.3902 | 0.4243 | 0.3922 | 0.4361 | 0.3964 | 0.4420 | 0.3985 |

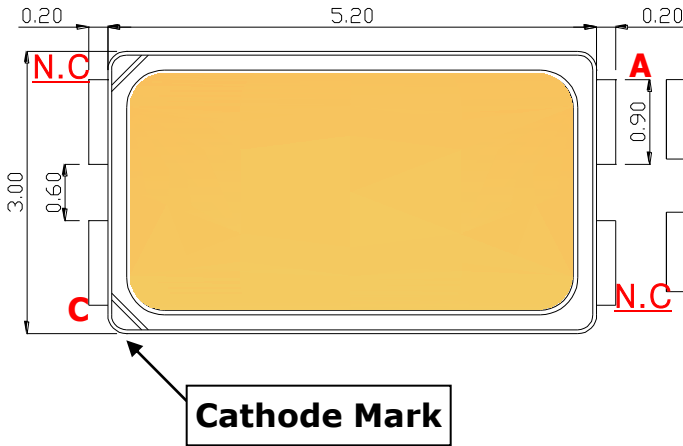
## Color Bin Structure

**CIE Chromaticity Diagram (Warm White),  $I_F = 20\text{mA}$ ,  $T_j = 25^\circ\text{C}$** 


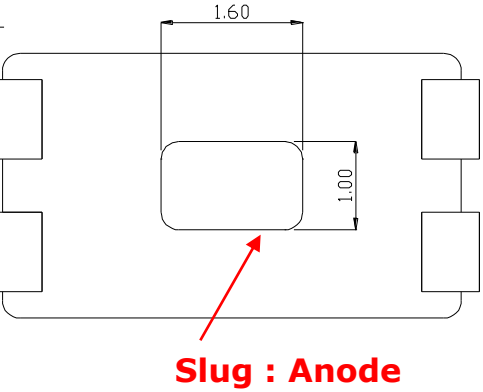
| H11    |        | H21    |        | H31    |        | H41    |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.4562 | 0.4260 | 0.4625 | 0.4275 | 0.4687 | 0.4289 | 0.4750 | 0.4304 |
| 0.4515 | 0.4168 | 0.4575 | 0.4182 | 0.4636 | 0.4197 | 0.4697 | 0.4211 |
| 0.4575 | 0.4182 | 0.4636 | 0.4197 | 0.4697 | 0.4211 | 0.4758 | 0.4225 |
| 0.4625 | 0.4275 | 0.4687 | 0.4289 | 0.4750 | 0.4304 | 0.4810 | 0.4319 |
| H12    |        | H22    |        | H32    |        | H42    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.4515 | 0.4168 | 0.4575 | 0.4182 | 0.4636 | 0.4197 | 0.4697 | 0.4211 |
| 0.4468 | 0.4077 | 0.4526 | 0.4090 | 0.4585 | 0.4104 | 0.4644 | 0.4118 |
| 0.4526 | 0.4090 | 0.4585 | 0.4104 | 0.4644 | 0.4118 | 0.4703 | 0.4132 |
| 0.4575 | 0.4182 | 0.4636 | 0.4197 | 0.4697 | 0.4211 | 0.4758 | 0.4225 |
| H13    |        | H23    |        | H33    |        | H43    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.4468 | 0.4077 | 0.4526 | 0.4090 | 0.4585 | 0.4104 | 0.4644 | 0.4118 |
| 0.4420 | 0.3985 | 0.4477 | 0.3998 | 0.4534 | 0.4012 | 0.4591 | 0.4025 |
| 0.4477 | 0.3998 | 0.4534 | 0.4012 | 0.4591 | 0.4025 | 0.4648 | 0.4038 |
| 0.4526 | 0.4090 | 0.4585 | 0.4104 | 0.4644 | 0.4118 | 0.4703 | 0.4132 |
| H14    |        | H24    |        | H34    |        | H44    |        |
| CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  | CIE X  | CIE Y  |
| 0.4420 | 0.3985 | 0.4477 | 0.3998 | 0.4534 | 0.4012 | 0.4591 | 0.4025 |
| 0.4373 | 0.3893 | 0.4428 | 0.3906 | 0.4483 | 0.3919 | 0.4538 | 0.3932 |
| 0.4428 | 0.3906 | 0.4483 | 0.3919 | 0.4538 | 0.3932 | 0.4593 | 0.3944 |
| 0.4477 | 0.3998 | 0.4534 | 0.4012 | 0.4591 | 0.4025 | 0.4648 | 0.4038 |

## Mechanical Dimensions

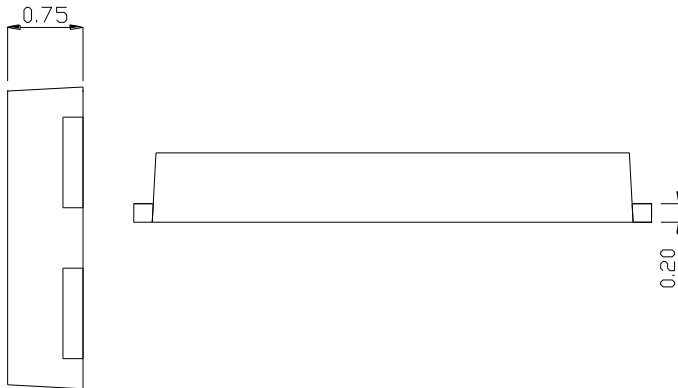
**Top View**



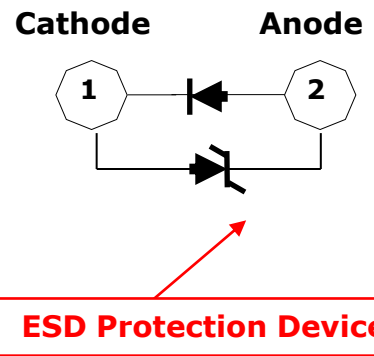
**Bottom View**



**Side View**



**Circuit**

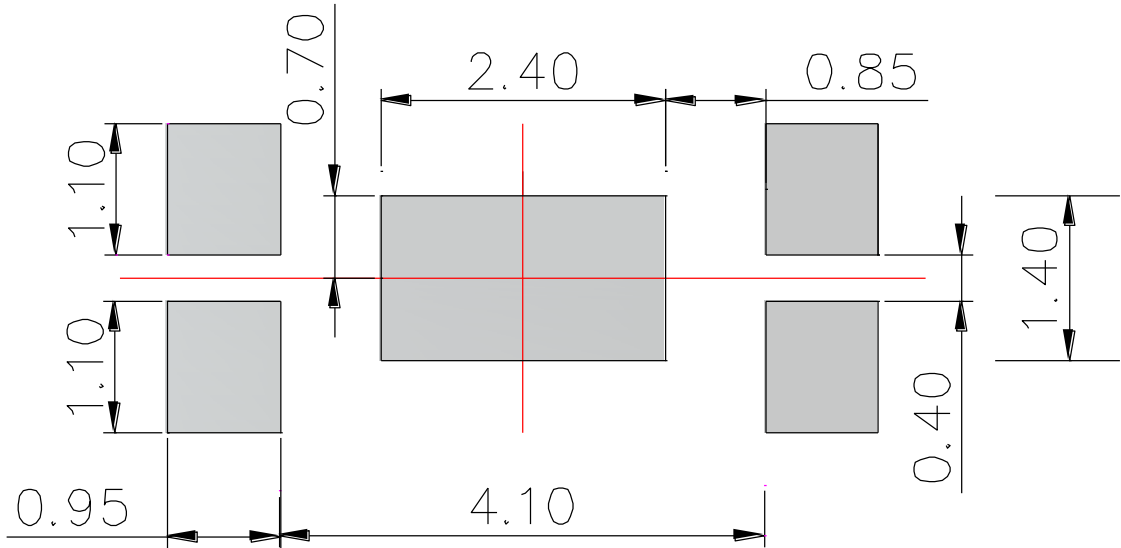


[Note] Package Forward Current is **20mA**

**Notes :**

- (1) All dimensions are in millimeters.
- (2) Scale : none
- (3) Undefined tolerance is  $\pm 0.1\text{mm}$

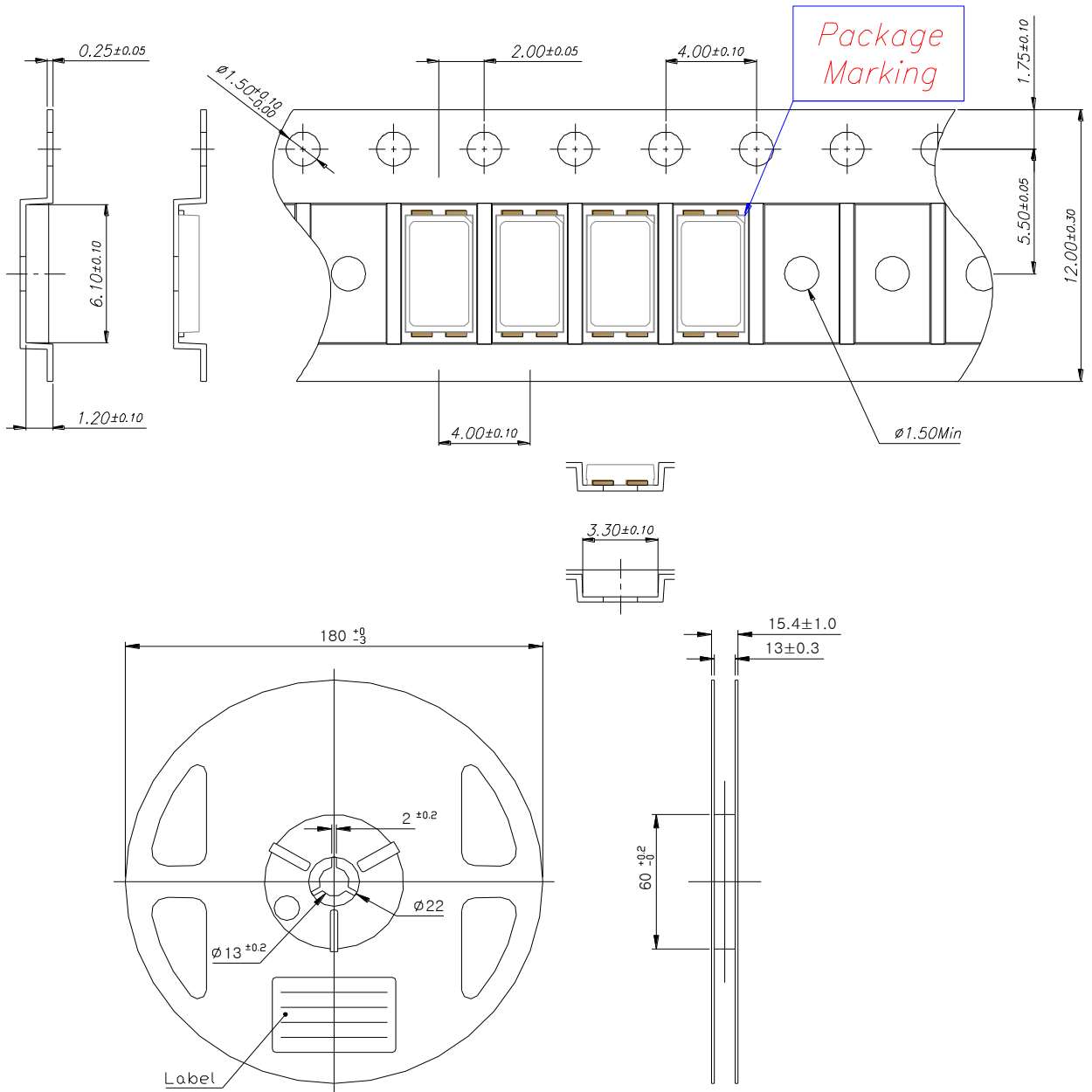
## Recommended Solder Pad


**Notes :**

- (1) All dimensions are in millimeters.
- (2) Scale : none
- (3) This drawing without tolerances are for reference only
- (4) Undefined tolerance is  $\pm 0.1\text{mm}$



## Emitter Tape & Reel Packaging



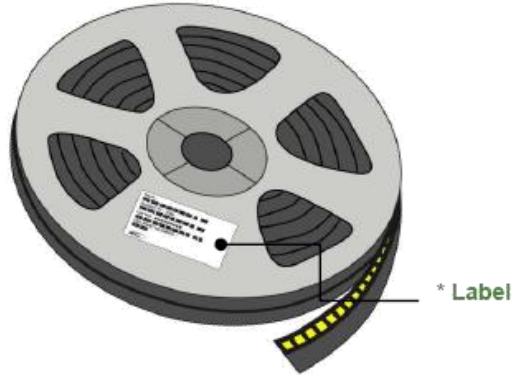
( Tolerance:  $\pm 0.2$ , Unit: mm )

**Notes :**

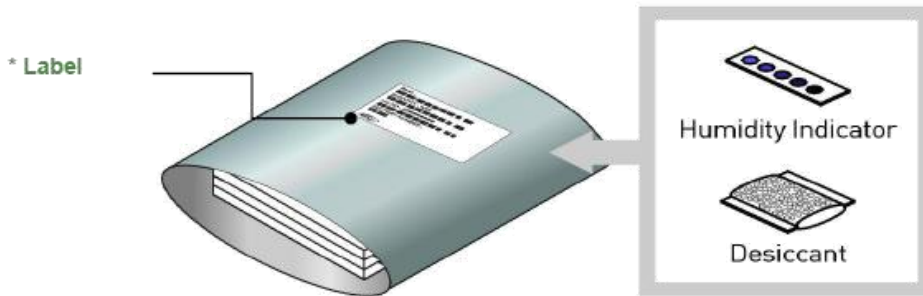
- (1) Quantity : 3,500pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be  $\pm 0.2$ mm
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of  $10^\circ$  to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof package

## Emitter Tape & Reel Packaging

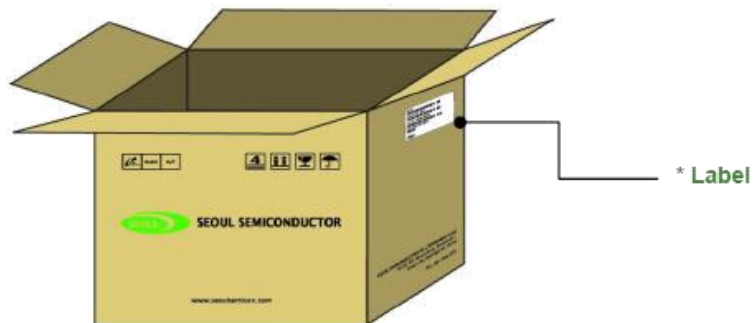
### Reel



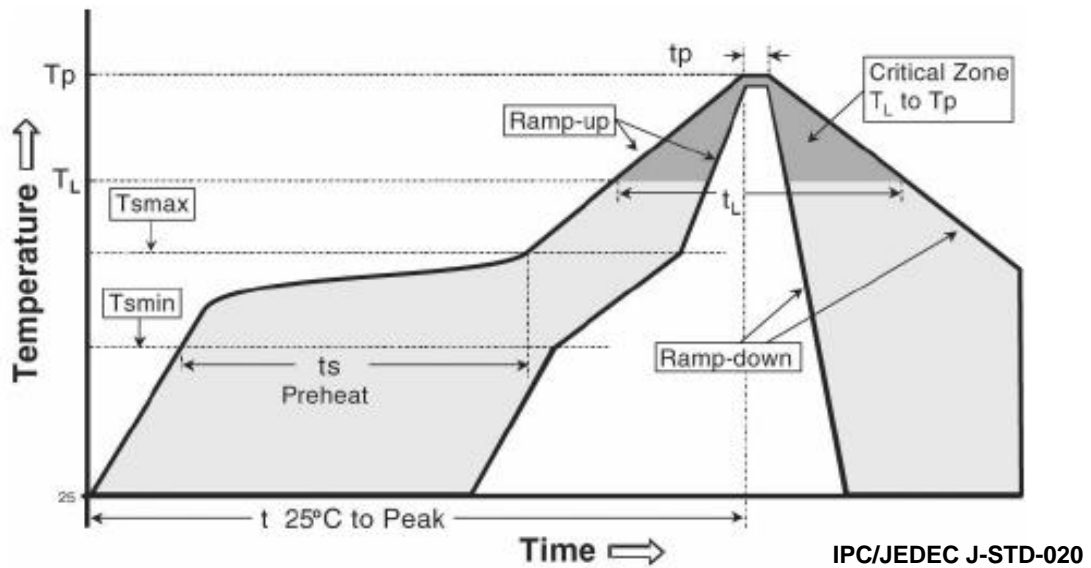
### Aluminum Bag



### Outer Box



## Reflow Soldering Characteristics


**Table 7.**

| Profile Feature   | Sn-Pb Eutectic Assembly            | Pb-Free Assembly                   |
|---|------------------------------------|------------------------------------|
| Average ramp-up rate (T <sub>max</sub> to T <sub>p</sub> )  | 3° C/second max.                   | 3° C/second max.                   |
| Preheat<br>- Temperature Min (T <sub>min</sub> )<br>- Temperature Max (T <sub>max</sub> )<br>- Time (T <sub>min</sub> to T <sub>max</sub> ) (t <sub>s</sub> ) | 100 °C<br>150 °C<br>60-120 seconds | 150 °C<br>200 °C<br>60-180 seconds |
| Time maintained above:<br>- Temperature (T <sub>L</sub> )<br>- Time (t <sub>L</sub> )   | 183 °C<br>60-150 seconds           | 217 °C<br>60-150 seconds           |
| Peak Temperature (T <sub>p</sub> )  | 215 °C                             | 260 °C                             |
| Time within 5°C of actual Peak Temperature (t <sub>p</sub> ) <sup>2</sup>   | 10-30 seconds                      | 20-40 seconds                      |
| Ramp-down Rate  | 6 °C/second max.                   | 6 °C/second max.                   |
| Time 25°C to Peak Temperature   | 6 minutes max.                     | 8 minutes max.                     |

### Caution

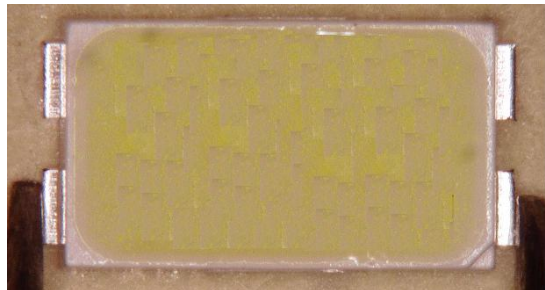
- (1) Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.

## Handling of Silicone Resin for LEDs

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



(2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.



(3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.

(4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust.

As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.

(5) SSC suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin.

Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.

(6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this product with acid or sulfur material in sealed space.

(7) Avoid leaving fingerprints on silicone resin parts.

## Precaution for Use

### (1) Storage

To avoid the moisture penetration, we recommend storing Z5 Series LEDs in a dry box with a desiccant. The recommended storage temperature range is 5 °C to 30 °C and a maximum humidity of RH50%.

### (2) Use Precaution after Opening the Packaging

Use proper SMD techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency. Pay attention to the following:

#### a. Recommend conditions after opening the package

- Sealing

- Temperature : 5 ~ 40 °C Humidity : less than RH30%

#### b. If the package has been opened more than 1 year (MSL 2) or the color of the desiccant changes, components should be dried for 10-12hr at 60±5 °C

### (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.

### (4) Do not rapidly cool device after soldering.

### (5) Components should not be mounted on warped (non coplanar) portion of PCB.

### (6) Radioactive exposure is not considered for the products listed here in.

### (7) Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or shredded in the process of disposal. It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.

### (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.

### (9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.

### (10) LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from Seoul Semiconductor.

a sealed container with a nitrogen atmosphere should be used for storage.

### (11) The appearance and specifications of the product may be modified for improvement without notice.

### (12) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.

### (13) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture.

Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.

### (14) The slug is electrically isolated.

### (15) Attaching LEDs, do not use adhesives that outgas organic vapor.

### (16) The driving circuit must be designed to allow forward voltage only when it is ON or OFF.

If the reverse voltage is applied to LED, migration can be generated resulting in LED damage

## Precaution for Use

(17) Similar to most Solid state devices;

LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS).

Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.

a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current
- Lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following Recommendations are suggested to help minimize the potential for an ESD event:

- One or more recommended work area suggestions:
  - Ionizing fan setup
  - ESD table/shelf mat made of conductive materials
  - ESD safe storage containers
- One or more personnel suggestion options:
  - Antistatic Wrist-strap
  - Antistatic material shoes
  - Antistatic clothes
- Environmental controls
  - Humidity control (ESD gets worse in a dry environment)

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device.

The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package (If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)
- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power
- Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures

It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred.

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
  - This damage usually appears due to the thermal stress produced during the EOS event.

To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:

- A surge protection circuit
  - An appropriately rated over voltage protection device
  - A current limiting device



## Company Information

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### Company Information

Seoul Semiconductor ([www.SeoulSemicon.com](http://www.SeoulSemicon.com)) manufactures and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

### Legal Disclaimer

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